



FIG. 1A

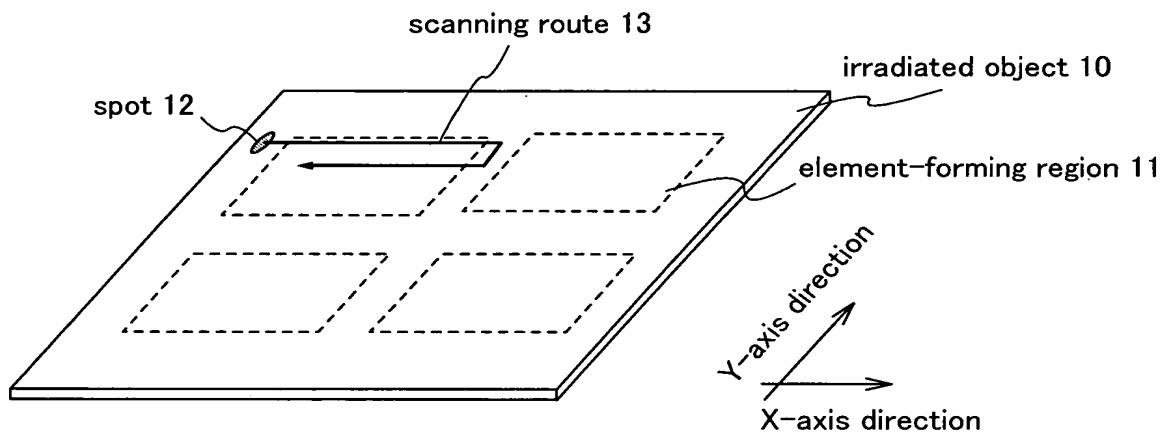


FIG. 1B

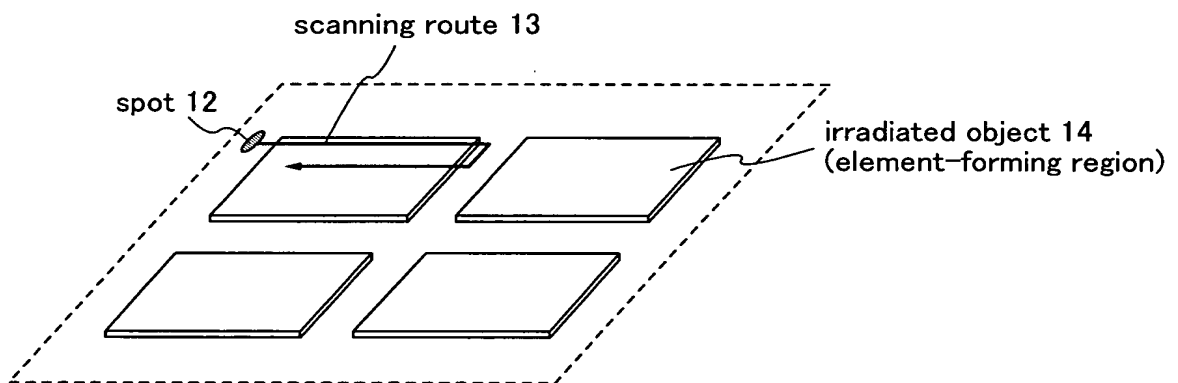


FIG. 2

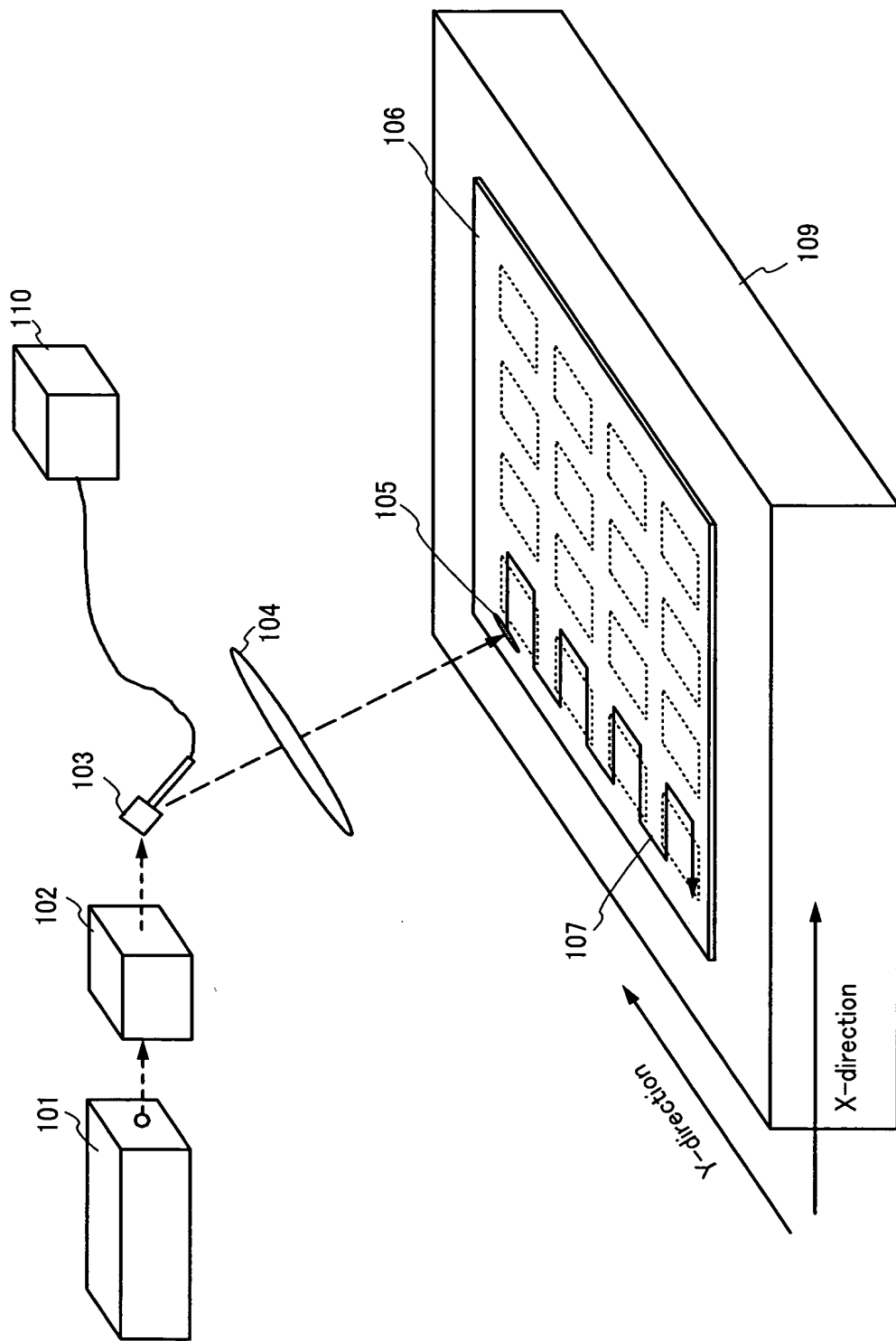


FIG. 3A

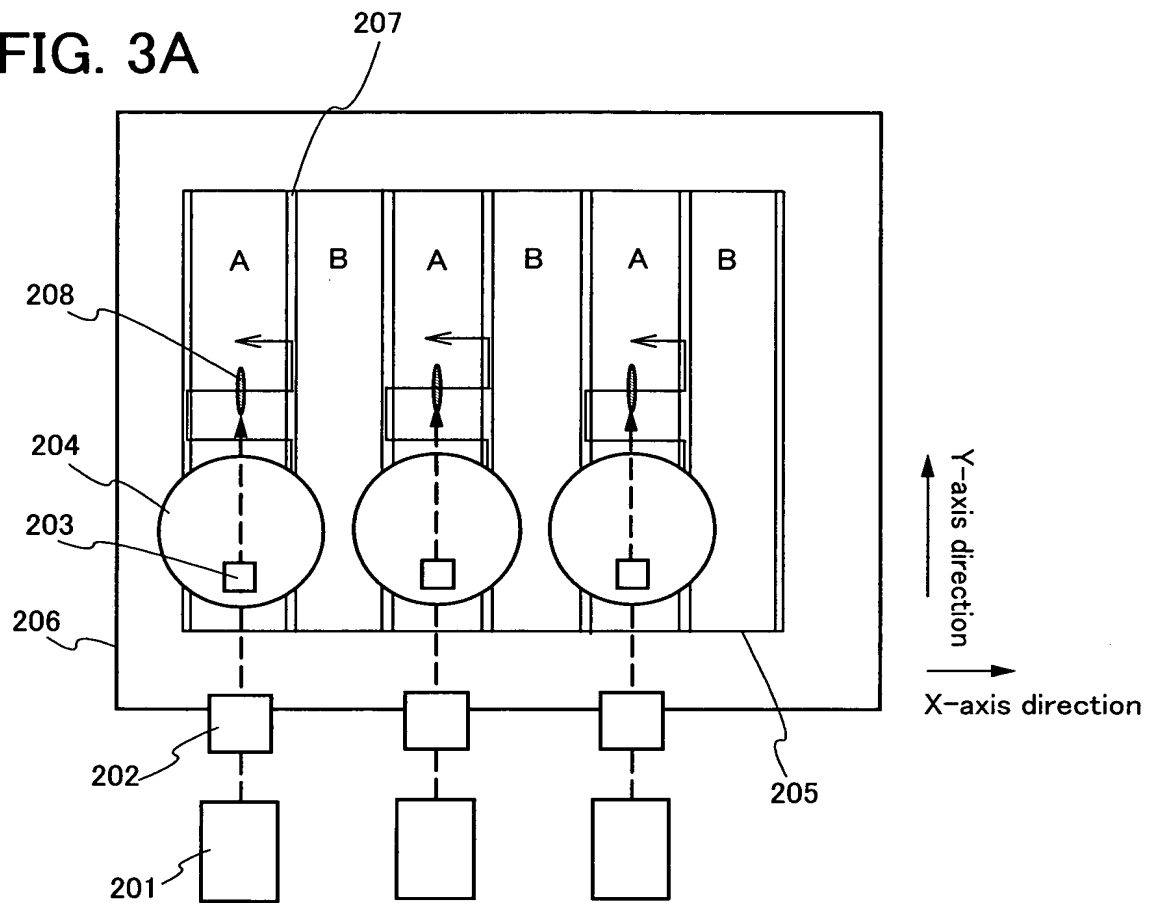
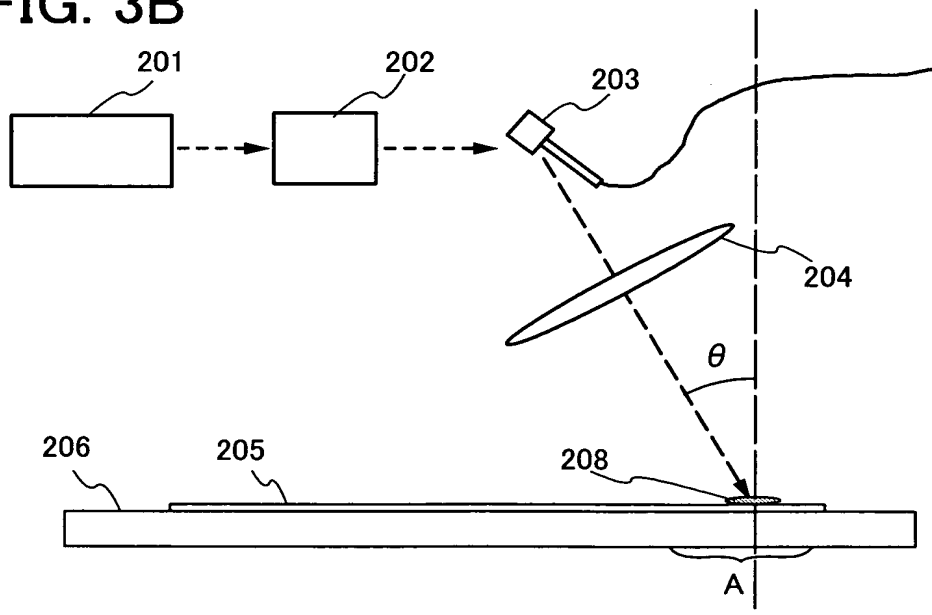


FIG. 3B



first conductive film 403

organic compound layer 405

second substrate 409

airspace 408

protective film 407

second conductive film 406

insulator 404

interlayer insulating film 402

base insulating film 401

417

channel-forming region 412

impurity region 411

416

418

first substrate 400

TFT422

airspace 408	
protective film 407	
second conductive film 406	
organic compound layer 405	EIL(electron injecting layer) _ _
	ETL(electron transporting layer) _ _
	EML(light-emitting layer) _ _
	HTL(hole transporting layer) _ _
	HIL(hole injecting layer)
first conductive film 403	
interlayer insulating film 402	

FIG. 5A

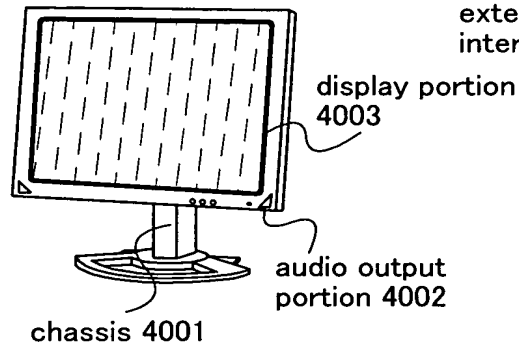


FIG. 5B

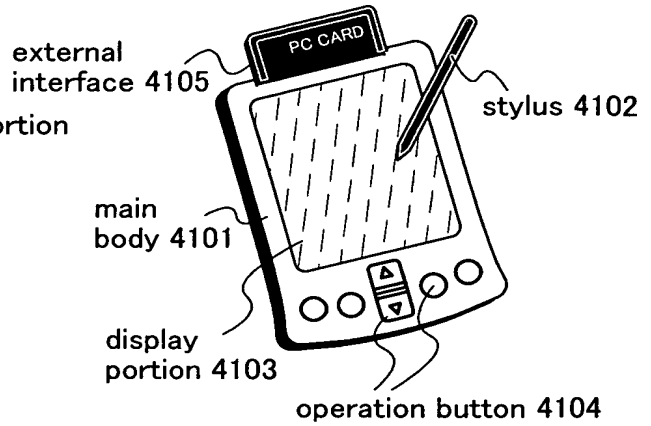


FIG. 5C

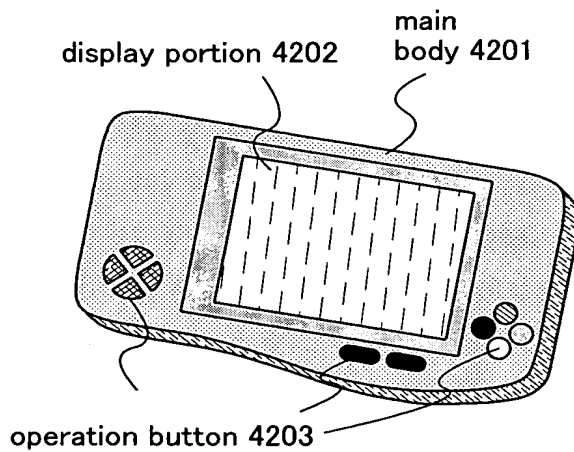


FIG. 5D

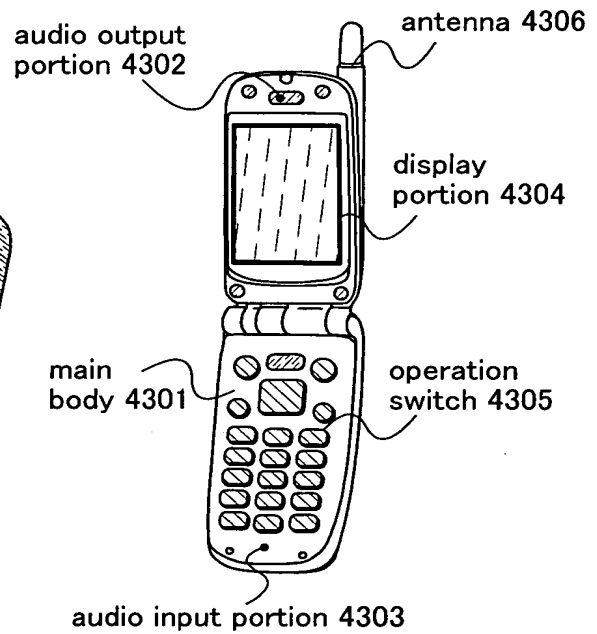


FIG. 5E

